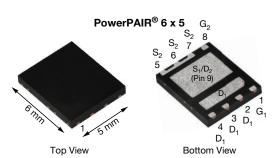




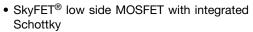
# Dual N-Channel 30 V (D-S) MOSFET with Schottky Diode



| PRODUCT SUMMARY   | 7                                      |           |  |  |
|---|--|-----------|--|--|
|   | CHANNEL-1                              | CHANNEL-2 |  |  |
| V <sub>DS</sub> (V)                                       | 30                                     | 30        |  |  |
| $R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS} = 10 \text{ V}$ | 0.0067                                 | 00.0016   |  |  |
| $R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS} = 4.5$ V        | 0.0100                                 | 0.0022    |  |  |
| Q <sub>g</sub> typ. (nC)                                  | 5.4                                    | 21        |  |  |
| I <sub>D</sub> (A) <sup>a</sup>                           | 20                                     | 60        |  |  |
| Configuration   | Dual plus integrated Schottky (SkyFET) |           |  |  |

#### **FEATURES**

• TrenchFET® Gen IV power MOSFET



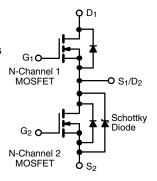
ROHS COMPLIANT HALOGEN FREE

• 100 % R<sub>a</sub> and UIS tested

 Material categorization: for definitions of compliance please see <a href="https://www.vishay.com/doc?99912">www.vishay.com/doc?99912</a>

#### **APPLICATIONS**

- CPU core power
- Computer / server peripherals
- POI
- Synchronous buck converter
- Telecom DC/DC



| ORDERING INFORMATION                                    |  |                |           |      |  |  |
|---|--|----------------|-----------|------|--|--|
| Package PowerPAIR 6 x 5                                 |  |                |           |      |  |  |
| Lead (Pb)-free and halogen-free                         | (Pb)-free and halogen-free SiZ980DT-T1-GE3 |                |           |      |  |  |
| <b>ABSOLUTE MAXIMUM RATINGS</b> (T <sub>A</sub> = 25 °C | C, unless ot                               | herwise noted) |           |      |  |  |
| PARAMETER   | SYMBOL                                     | CHANNEL-1      | CHANNEL-2 | UNIT |  |  |

| PARAMETER  | SYMBOL                  | CHANNEL-1                         | CHANNEL-2            | UNIT            |     |
|--|-------------------------|-----------------------------------|----------------------|-----------------|-----|
| Drain-source voltage   |                         | $V_{DS}$                          | 30                   | 30              | V   |
| Gate-source voltage  |                         | V <sub>GS</sub>                   | +20, -16             | +20, -16        | v   |
|  | T <sub>C</sub> = 25 °C  |                                   | 20 a                 | 60 a            |     |
| Continues during suggest (T. 150 °C)   | T <sub>C</sub> = 70 °C  | l , 🗀                             | 20 a                 | 60 a            |     |
| Continuous drain current (T <sub>J</sub> = 150 °C)   | T <sub>A</sub> = 25 °C  | I <sub>D</sub>                    | 18.8 <sup>b, c</sup> | 43 b, c         |     |
|  | T <sub>A</sub> = 70 °C  |                                   | 14.6 <sup>b, c</sup> | 34 b, c         |     |
| Pulsed drain current (t = 100 μs)  |                         | I <sub>DM</sub>                   | 90                   | 130             | _ A |
| Continue of the desired of the continue of the | T <sub>C</sub> = 25 °C  |                                   | 20 a                 | 55 <sup>a</sup> |     |
| Continuous source-drain diode current  | T <sub>A</sub> = 25 °C  | l <sub>S</sub>                    | 3.2 b, c             | 4.1 b, c        |     |
| Single pulse avalanche current   | . 0.4!!                 | I <sub>AS</sub>                   | 15                   | 25              |     |
| Single pulse avalanche energy  | L = 0.1 mH              |                                   | 11.2                 | 31              | mJ  |
|  | T <sub>C</sub> = 25 °C  |                                   | 20                   | 66              |     |
| Mandan and a sure discipation  | T <sub>C</sub> = 70 °C  |                                   | 12.9                 | 42              | w   |
| Maximum power dissipation  | T <sub>A</sub> = 25 °C  | P <sub>D</sub>                    | 3.8 b, c             | 5 b, c          | VV  |
|  | T <sub>A</sub> = 70 °C  | 1                                 | 2.4 <sup>b, c</sup>  | 3.2 b, c        |     |
| Operating junction and storage temperature range   |                         | T <sub>J</sub> , T <sub>stg</sub> | -55 to +150          |                 |     |
| Soldering recommendations (peak tempe  | rature) <sup>d, e</sup> |                                   | 26                   | → °C            |     |

| THERMAL RESISTANCE RATING        | GS           |                   |           |      |           |     |       |  |
|----------------------------------|--------------|-------------------|-----------|------|-----------|-----|-------|--|
| PARAMETER                        |              | SYMBOL            | CHANNEL-1 |      | CHANNEL-2 |     | LINUT |  |
| PARAMETER                        |              | STIVIDUL          | TYP.      | MAX. | TYP. MAX. |     | UNIT  |  |
| Maximum junction-to-ambient b, f | t ≤ 10 s     | R <sub>thJA</sub> | 26        | 33   | 20        | 25  | °C/W  |  |
| Maximum junction-to-case (drain) | Steady state | $R_{thJC}$        | 4.7       | 6.2  | 1.5       | 1.9 | C/VV  |  |

#### Notes

- a. Package limited
- b. Surface mounted on 1" x 1" FR4 board
- c. t = 10 s
- d. See solder profile (www.vishav.com/doc?73257). The PowerPAIR is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection
- e. Rework conditions: manual soldering with a soldering iron is not recommended for leadless components
- f. Maximum under steady state conditions is 68 °C/W for channel-1 and 57 °C/W for channel-2

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| PARAMETER                                     | SYMBOL              | TEST CONDITIONS   |      | MIN. | TYP.   | MAX.   | UNIT |
|---|---------------------|---|------|------|--------|--------|------|
| Static  |                     |   |      | L    | L      |        | l    |
|   | ٠,,                 |   | Ch-1 | 30   | -      | -      |      |
| Drain-source breakdown voltage                | V <sub>DS</sub>     | $V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$                                 | Ch-2 | 30   | -      | -      |      |
| Drain-source breakdown voltage <sup>c</sup>   | .,                  | V 0V 1  | Ch-1 | 36   | -      | -      | ,,   |
| (transient)                                   | V <sub>DSt</sub>    | $V_{GS} = 0 \text{ V}, t_{transient} \leq 1  \mu s$                           | Ch-2 | 36   | -      | -      | V    |
| Onto a common thomas had a coltant            |                     | V V I 050 ·· A  | Ch-1 | 1.2  | -      | 2.2    |      |
| Gate-source threshold voltage                 | V <sub>GS(th)</sub> | $V_{DS} = V_{GS}$ , $I_D = 250 \mu A$   | Ch-2 | 1.1  | -      | 2.2    |      |
| Cata agura laglaga                            |                     | V 0VV .20V 16V  | Ch-1 | -    | -      | ± 100  | A    |
| Gate-source leakage                           | I <sub>GSS</sub>    | $V_{DS} = 0 \text{ V}, V_{GS} = +20 \text{ V}, -16 \text{ V}$                 | Ch-2 | -    | -      | ± 100  | nA   |
|   |                     | V 20 V V 20 V   | Ch-1 | -    | -      | 1      |      |
| Zana mata valta sa aluain avenus              |                     | $V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}$                                 | Ch-2 | -    | 20     | 100    |      |
| Zero gate voltage drain current               | I <sub>DSS</sub>    | V 00 V V 0 V T 55 00  | Ch-1 | -    | -      | 5      | μA   |
|   |                     | $V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55 ^{\circ}\text{C}$    | Ch-2 | -    | 100    | 1000   |      |
| O salala dada sa sa al b                      |                     | V > 5 V V 40 V  | Ch-1 | 20   | -      | -      | _    |
| On-state drain current <sup>b</sup>           | I <sub>D(on)</sub>  | $V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$                               | Ch-2 | 20   | -      | -      | Α    |
|   |                     | V <sub>GS</sub> = 10 V, I <sub>D</sub> = 15 A                                 | Ch-1 | -    | 0.0047 | 0.0067 |      |
| Drain-source on-state resistance <sup>b</sup> |                     | V <sub>GS</sub> = 10 V, I <sub>D</sub> = 19 A                                 | Ch-2 | -    | 0.0011 | 0.0016 |      |
|   | R <sub>DS(on)</sub> | V <sub>GS</sub> = 4.5 V, I <sub>D</sub> = 12 A                                | Ch-1 | -    | 0.0065 | 0.0100 | Ω    |
|   |                     | V <sub>GS</sub> = 4.5 V, I <sub>D</sub> = 15 A                                | Ch-2 | -    | 0.0016 | 0.0022 |      |
|   |                     | V <sub>DS</sub> = 10 V, I <sub>D</sub> = 15 A                                 | Ch-1 | -    | 80     | -      |      |
| Forward transconductance <sup>b</sup>         | 9 <sub>fs</sub>     | V <sub>DS</sub> = 10 V, I <sub>D</sub> = 19 A                                 | Ch-2 |      | 155    | -      | S    |
| Dynamic <sup>a</sup>                          |                     | 20 2  |      | L    |        |        |      |
|   |                     |   | Ch-1 | -    | 930    | -      |      |
| Input capacitance                             | C <sub>iss</sub>    |   | Ch-2 | -    | 4600   | -      |      |
| 0.1.1   |                     | Channel-1   | Ch-1 | -    | 325    | -      | _    |
| Output capacitance                            | C <sub>oss</sub>    | $V_{DS} = 15 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$              | Ch-2 | -    | 1700   | -      | pF   |
|   |                     |   | Ch-1 | -    | 21     | -      |      |
| Reverse transfer capacitance                  | $C_{rss}$           | Channel-2<br>$V_{DS} = 15 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$ | Ch-2 | -    | 115    | -      |      |
|   |                     | VDS = 13 V, VGS = 0 V, I = 1 WI112  | Ch-1 | -    | 0.023  | 0.046  |      |
| C <sub>rss</sub> /C <sub>iss</sub> ratio      |                     |   | Ch-2 |      | 0.025  | 0.050  |      |
|   |                     | V <sub>DS</sub> = 15 V, V <sub>GS</sub> = 10 V, I <sub>D</sub> = 19 A         | Ch-1 | -    | 12     | 18     |      |
|   |                     | $V_{DS} = 15 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 19 \text{ A}$            | Ch-2 | -    | 51     | 77     |      |
| Total gate charge                             | $Q_g$               | $V_{DS} = 15 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 19 \text{ A}$         | Ch-1 |      | 5.4    | 8.1    | 1    |
|   |                     | V <sub>DS</sub> = 15 V, V <sub>GS</sub> = 4.5 V, I <sub>D</sub> = 19 A        | Ch-2 | -    | 23     | 35     |      |
|   |                     | Channel-1   | Ch-1 | -    | 3      | -      |      |
| Gate-source charge                            | $Q_{gs}$            | $V_{DS} = 15 \text{ V}, V_{GS} = 4.5 \text{ V}, I_D = 19 \text{ A}$           | Ch-2 | -    | 12.2   | -      | nC   |
|   |                     |   | Ch-1 | -    | 0.75   | -      |      |
| Gate-drain charge                             | $Q_{gd}$            | Channel-2 $V_{DS} = 15 \text{ V}, V_{GS} = 4.5 \text{ V}, I_D = 19 \text{ A}$ | Ch-2 | -    | 2.2    | -      |      |
| Outrot shares                                 |                     |   | Ch-1 | -    | 10     | -      |      |
| Output charge                                 | Q <sub>oss</sub>    | $V_{DS} = 15 \text{ V}, V_{GS} = 0 \text{ V}$                                 | Ch-2 | -    | 54     | -      |      |
|   | _                   |   | Ch-1 | 0.3  | 1.5    | 3      | _    |
| Gate resistance                               | $R_g$               | f = 1 MHz   | Ch-2 | 0.2  | 1      | 2      | Ω    |



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| PARAMETER                                | SYMBOL              | TEST CONDITIONS   | MIN.         | TYP. | MAX.     | UNIT   |    |
|--|---------------------|---|--------------|------|----------|--|----|
| Dynamic <sup>a</sup>                     |                     |   |              |      |          |  |    |
| Turn-on delay time                       | +                   |   | Ch-1 - 15    | 15   | 30       |  |    |
| Turn-on delay time                       | t <sub>d(on)</sub>  | Channel-1   | Ch-2         | -    | 35       | 70   |    |
| Rise time                                | tr                  | $V_{DD}$ = 15 V, $R_L$ = 1.5 $\Omega$<br>$I_D \cong$ 10 A, $V_{GEN}$ = 4.5 V, $R_\alpha$ = 1 $\Omega$ | Ch-1         | -    | 65       | 130  |    |
| Tilse time                               | ٠r                  | 1D = 107, VGEN = 110 V, Fig = 111   | Ch-2         | -    | 75       | 150  |    |
| Turn-off delay time                      | t <sub>d(off)</sub> | Channel-2   | Ch-1         | =    | 10       | 20   |    |
| Tam on dolay amo                         | -a(on)              | $V_{DD} = 15 \text{ V}, R_{L} = 1.5 \Omega$   | Ch-2         | -    | 30       | 60   |    |
| Fall time                                | t <sub>f</sub>      | $I_D \cong 10 \text{ Å}, V_{GEN} = 4.5 \text{ V}, R_g = 1 \Omega$                                     | Ch-1         | -    | 10       | 20   |    |
| T dil dillo                              | 4                   |   | Ch-2         | -    | 10       | 20   | ns |
| Turn-on delay time                       | t <sub>d(on)</sub>  |   | Ch-1         | -    | 10       | 20   |    |
| Turn on dolay time                       | -d(on)              | Channel-1   | Ch-2         | -    | 15       | 30   |    |
| Rise time                                | t <sub>r</sub>      | $V_{DD}$ = 15 V, $R_L$ = 1.5 $\Omega$<br>$I_D \cong$ 10 A, $V_{GEN}$ = 10 V, $R_q$ = 1 $\Omega$       | Ch-1         | -    | 25       | 50   |    |
|  | ٦                   | B - A GEN - A g   | Ch-2         | -    | 21       | 40   |    |
| Turn-off delay time                      | t <sub>d(off)</sub> | Channel-2 $V_{DD} = 15 \text{ V}, R_L = 1.5 \Omega$   | Ch-1         | -    | 15       | 30   |    |
|  | -4(011)             |   | Ch-2         | -    | 32       | 60   |    |
| Fall time                                | $t_f$               | $I_D \cong 10 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$                                      | Ch-1         | -    | 10       | 20   |    |
|  | ·                   |   | Ch-2         | -    | 10       | 20   |    |
| Drain-Source Body Diode Characteris      | stics               |   | T            | ı    | I        |  | Π  |
| Continuous source-drain diode current    | Is                  | T <sub>C</sub> = 25 °C  | Ch-1         | -    | -        | 20   |    |
|  |                     | -   | Ch-2         | -    | -        | 60   | Α  |
| Pulse diode forward current <sup>a</sup> | I <sub>SM</sub>     |   | Ch-1         | -    | -        | 90   | _  |
|  |                     |   | Ch-2         | -    | -        | 130  |    |
| Body diode voltage                       | $V_{SD}$            | $I_S = 10 \text{ A}, V_{GS} = 0 \text{ V}$  | Ch-1         | -    | 0.8      | 1.2  | V  |
|  |                     |   | Ch-2         | -    | 0.58     | 0.87   |    |
| Body diode reverse recovery time         | t <sub>rr</sub>     | Channel-1   | Ch-1         | -    | 30       | 60   | ns |
|  | Q <sub>rr</sub>     | l <sub>F</sub> = 10 A, di/dt = 100 A/μs,  | Ch-2         | -    | 50       | 100  |    |
| Body diode reverse recovery charge       |                     | T <sub>J</sub> = 25 °C  | Ch-1<br>Ch-2 | -    | 11<br>28 | 20<br>60   | nC |
|  |                     |   |              | -    | 18       | 00   |    |
| Reverse recovery fall time               | t <sub>a</sub>      | Channel-2   | Ch-1<br>Ch-2 | -    | 28       | <del>                                     </del> | 1  |
| •  | t <sub>b</sub>      | $I_F = 10 \text{ A, di/dt} = 100 \text{ A/}\mu\text{s,}$<br>$T_{.1} = 25 ^{\circ}\text{C}$            | Ch-2         | -    | 12       | -  | ns |
| I I                                      |                     |   |              |      |          |  |    |

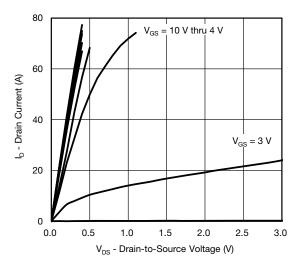
#### Notes

- a. Guaranteed by design, not subject to production testing
- b. Pulse test; pulse width  $\leq 300~\mu s,$  duty cycle  $\leq 2~\%$
- c. Derived from UIS characterization data at time of product release. Production data log is not available

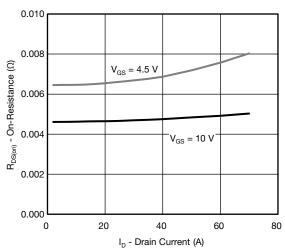
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



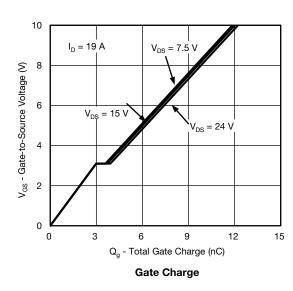
# CHANNEL-1 TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

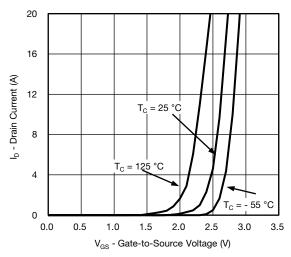


#### **Output Characteristics**

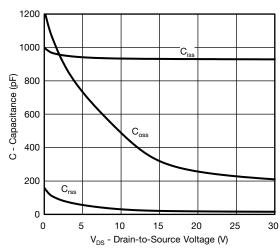


On-Resistance vs. Drain Current

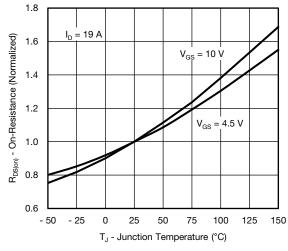




**Transfer Characteristics** 



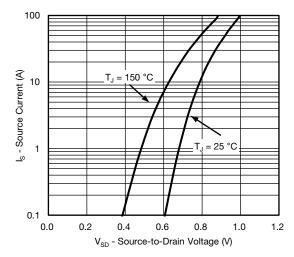
Capacitance



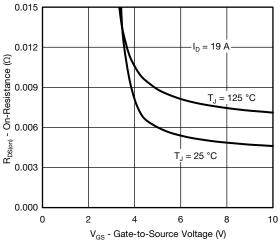
On-Resistance vs. Junction Temperature



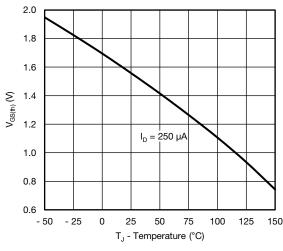
### CHANNEL-1 TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



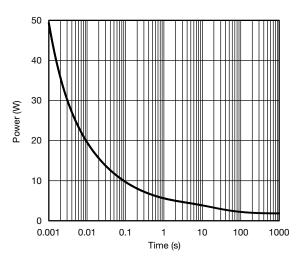
#### Source-Drain Diode Forward Voltage



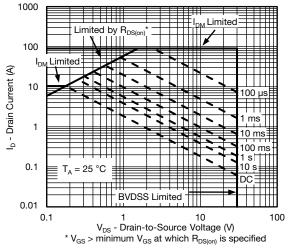
On-Resistance vs. Gate-to-Source Voltage



**Threshold Voltage** 



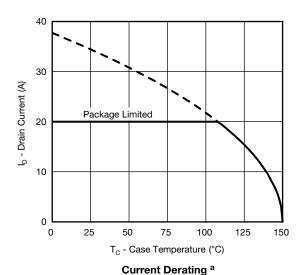
Single Pulse Power, Junction-to-Ambient

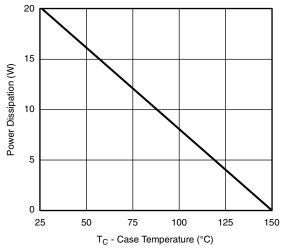


Safe Operating Area, Junction-to-Ambient

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### CHANNEL-1 TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



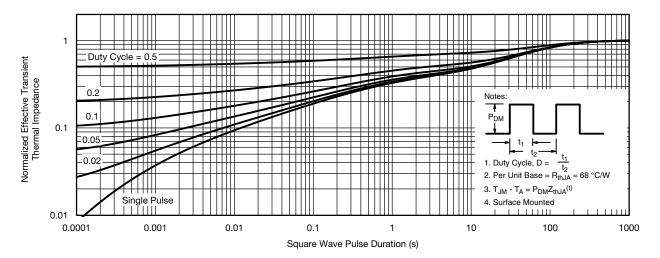


Power, Junction-to-Case

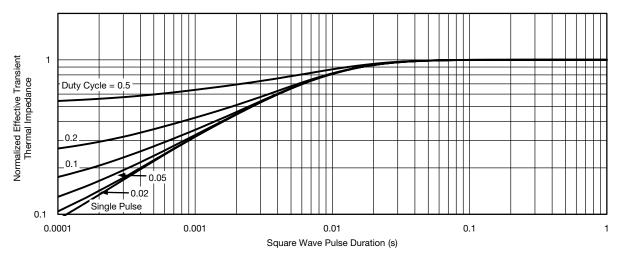
#### Note

a. The power dissipation  $P_D$  is based on  $T_J$  max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit

### CHANNEL-1 TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



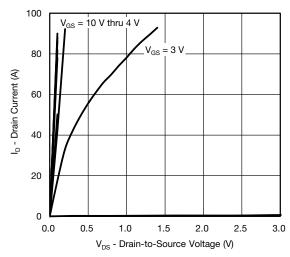
Normalized Thermal Transient Impedance, Junction-to-Ambient



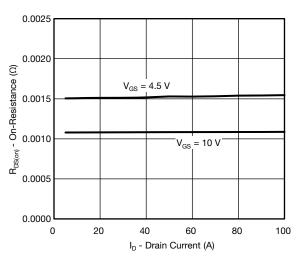
Normalized Thermal Transient Impedance, Junction-to-Case



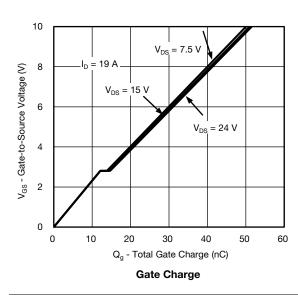
### CHANNEL-2 TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



#### **Output Characteristics**

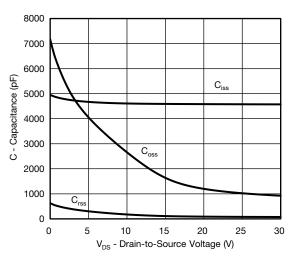


On-Resistance vs. Drain Current

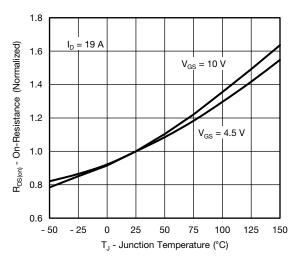


20 16 I<sub>D</sub> - Drain Current (A) 12 8  $T_C = 125 \,^{\circ}C$ 4 - 55 °C 0 0.5 0.0 1.0 1.5 2.0 2.5 3.0 3.5 V<sub>GS</sub> - Gate-to-Source Voltage (V)

**Transfer Characteristics** 



Capacitance

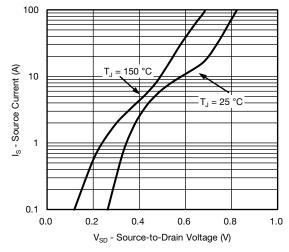


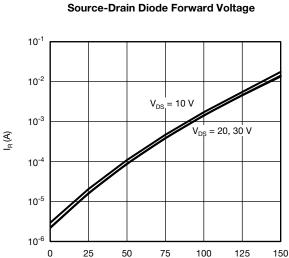
On-Resistance vs. Junction Temperature

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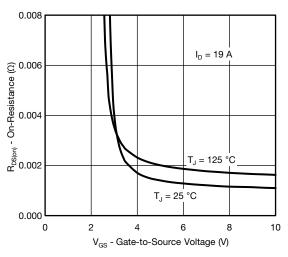


### CHANNEL-2 TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

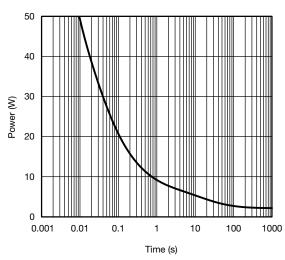




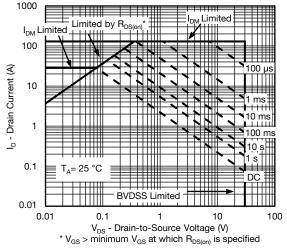
T<sub>J</sub> - Temperature (°C) **Threshold Voltage** 



On-Resistance vs. Gate-to-Source Voltage



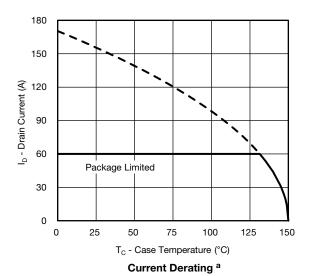
Single Pulse Power, Junction-to-Ambient

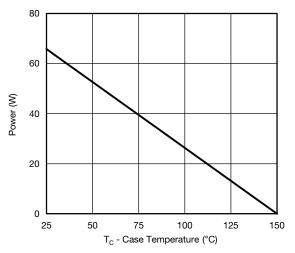


Safe Operating Area, Junction-to-Ambient

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### CHANNEL-2 TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)





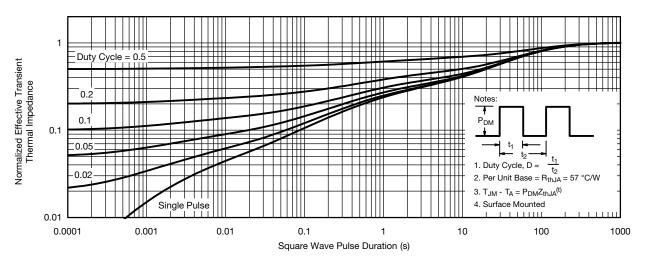
Power, Junction-to-Case

#### Note

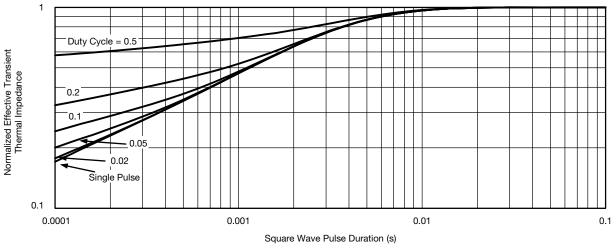
a. The power dissipation  $P_D$  is based on  $T_J$  max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit



# CHANNEL-2 TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient

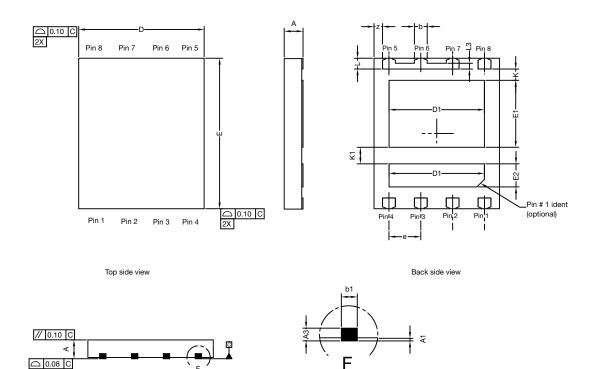


Normalized Thermal Transient Impedance, Junction-to-Case

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see <a href="https://www.vishay.com/ppg?62976">www.vishay.com/ppg?62976</a>.



# PowerPAIR® 6 x 5 Case Outline

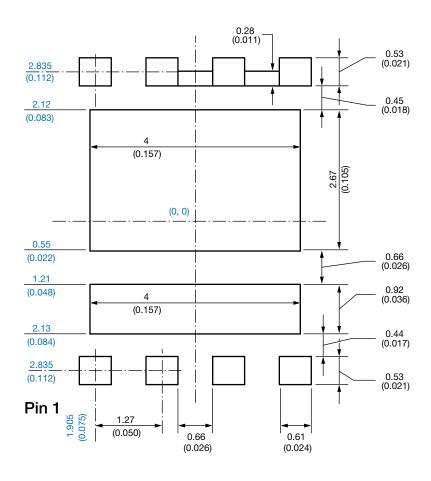


|                        |           | MILLIMETERS |      | INCHES     |   |       |  |
|------------------------|-----------|-------------|------|------------|---|-------|--|
| DIM.                   | MIN.      | NOM.        | MAX. | MIN.       | NOM.  | MAX.  |  |
| А                      | 0.70      | 0.75        | 0.80 | 0.028      | 0.030   | 0.032 |  |
| A1                     | 0.00      | -           | 0.10 | 0.000      | -   | 0.004 |  |
| A3                     | 0.15      | 0.20        | 0.25 | 0.006      | 0.007   | 0.009 |  |
| b                      | 0.43      | 0.51        | 0.61 | 0.017      | 0.020   | 0.024 |  |
| b1                     |           | 0.25 BSC    |      |            | 0.010 BSC  0.196  0.150  0.236  0.105  0.105  0.105 |       |  |
| D                      | 4.90      | 5.00        | 5.10 | 0.192      | 0.196   | 0.200 |  |
| D1                     | 3.75      | 3.80        | 3.85 | 0.148      | 0.150   | 0.152 |  |
| E                      | 5.90      | 6.00        | 6.10 | 0.232      | 0.236   | 0.240 |  |
| E1 Option AA (for W/B) | 2.62      | 2.67        | 2.72 | 0.103      | 0.105   | 0.107 |  |
| E1 Option AB (for BWL) | 2.42      | 2.47        | 2.52 | 0.095      | 0.097   | 0.099 |  |
| E2                     | 0.87      | 0.92        | 0.97 | 0.034      | 0.036   | 0.038 |  |
| е                      |           | 1.27 BSC    |      |            | 0.050 BSC   |       |  |
| K Option AA (for W/B)  | 0.45 typ. |             |      |            | 0.018 typ.  |       |  |
| K Option AB (for BWL)  |           | 0.65 typ.   |      |            | 0.025 typ.  |       |  |
| K1                     |           | 0.66 typ.   |      | 0.025 typ. |   |       |  |
| L                      | 0.33      | 0.43        | 0.53 | 0.013      | 0.017   | 0.020 |  |
| L3                     | 0.23 BSC  |             |      | 0.009 BSC  |   |       |  |
| Z                      | 0.34 BSC  |             |      | 0.013 BSC  |   |       |  |

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# Recommended Minimum PAD for PowerPAIR® 6 x 5



Dimensions in millimeters (inch)

#### Note

• Linear dimensions are in black, the same information is provided in ordinate dimensions which are in blue.



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